

Triacs

BT136S series

GENERAL DESCRIPTION

Passivated triacs in a plastic envelope, suitable for surface mounting, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

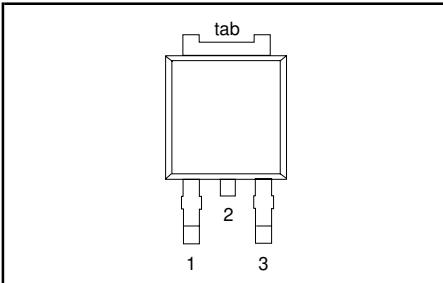
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
	BT136S - BT136S -	600 600F	800 800F	
V_{DRM}	Repetitive peak off-state voltages	600	800	V
$I_{T(RMS)}$	RMS on-state current	4	4	A
I_{TSM}	Non-repetitive peak on-state current	25	25	A

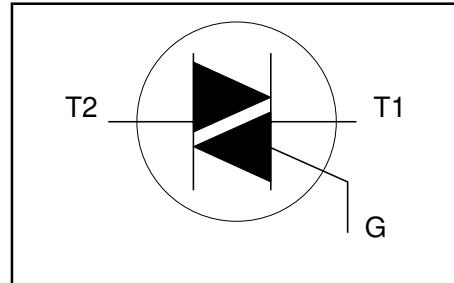
PINNING - SOT428

PIN	DESCRIPTION
1	MT1
2	MT2
3	gate
tab	MT2

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DRM}	Repetitive peak off-state voltages		-	-600 600 ¹	V
$I_{T(RMS)}$ I_{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{mb} \leq 107^\circ\text{C}$ full sine wave; $T_j = 25^\circ\text{C}$ prior to surge $t = 20\text{ ms}$ $t = 16.7\text{ ms}$ $t = 10\text{ ms}$ $I_{TM} = 6\text{ A}$; $I_G = 0.2\text{ A}$; $dI_G/dt = 0.2\text{ A}/\mu\text{s}$	-	4	A
I^2t dI_t/dt	I^2t for fusing Repetitive rate of rise of on-state current after triggering		-	25 27 3.1	A ² s
I_{GM} V_{GM} P_{GM} $P_{G(AV)}$ T_{stg} T_j	Peak gate current Peak gate voltage Peak gate power Average gate power Storage temperature Operating junction temperature	over any 20 ms period	T2+ G+ T2+ G- T2- G- T2- G+	50 50 50 10 2 5 5 0.5 150 125	A/ μs A/ μs A/ μs A/ μs A V W W °C °C

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 A/ μs .

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j\text{-}mb}$	Thermal resistance junction to mounting base	full cycle	-	-	3.0	K/W
$R_{th\ j\text{-}a}$	Thermal resistance junction to ambient	half cycle pcb (FR4) mounted; footprint as in Fig.14	-	75	3.7	K/W

STATIC CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.		UNIT
					...F	...F	
I_{GT}	Gate trigger current	$V_D = 12\text{ V}; I_T = 0.1\text{ A}$	BT136S-		mA
			T2+ G+	-	5	35	
			T2+ G-	-	8	35	
			T2- G-	-	11	35	
I_L	Latching current	$V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$	T2- G+	-	30	70	mA
			T2+ G+	-	7	20	
			T2+ G-	-	16	30	
			T2- G-	-	5	20	
I_H	Holding current	$V_D = 12\text{ V}; I_{GT} = 0.1\text{ A}$	T2- G+	-	7	30	mA
			T2- G+	-	5	15	
			T2+ G+	-	15	15	
			T2+ G-	-	5	15	
V_T	On-state voltage	$I_T = 5\text{ A}$	-	1.4	1.70		V
			-	0.7	1.5		V
V_{GT}	Gate trigger voltage	$V_D = 12\text{ V}; I_T = 0.1\text{ A}$	0.25	0.4	-		V
			$V_D = 400\text{ V}; I_T = 0.1\text{ A}; T_j = 125^\circ\text{C}$	-	0.1	0.5	mA
I_D	Off-state leakage current	$V_D = V_{DRM(\text{max})}; T_j = 125^\circ\text{C}$	-				

DYNAMIC CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.		TYP.	MAX.	UNIT
dV_D/dt	Critical rate of rise of off-state voltage	BT136S (or BT136M)- $V_{DM} = 67\% V_{DRM(\text{max})}$; $T_j = 125^\circ\text{C}$; exponential waveform; gate open circuit	...	100	50	250	-
dV_{com}/dt	Critical rate of change of commutating voltage	$V_{DM} = 400\text{ V}; T_j = 95^\circ\text{C}$; $I_{T(\text{RMS})} = 4\text{ A}$; $dI_{com}/dt = 1.8\text{ A/ms}$; gate open circuit	-	-	50	-	V/ μ s
t_{gt}	Gate controlled turn-on time	$I_{TM} = 6\text{ A}; V_D = V_{DRM(\text{max})}$; $I_G = 0.1\text{ A}$; $dI_G/dt = 5\text{ A}/\mu\text{s}$	-	-	2	-	μ s

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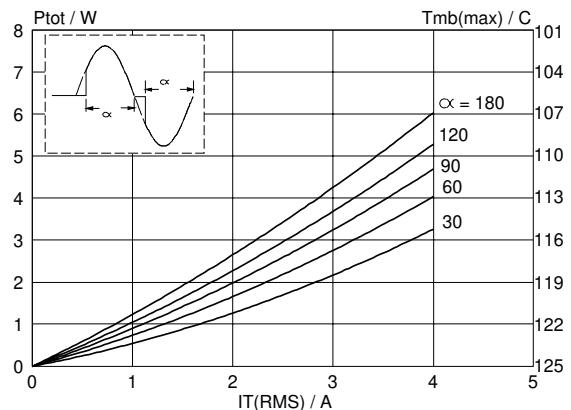


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where α = conduction angle.

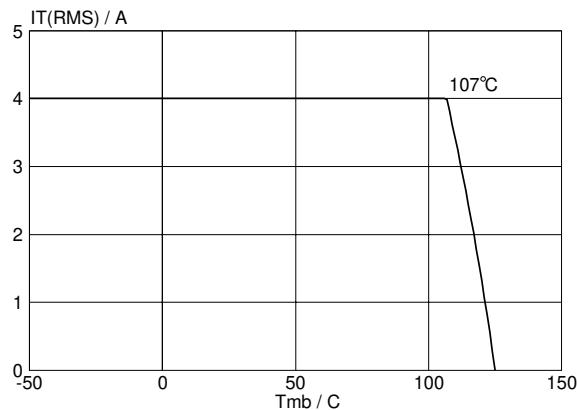


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

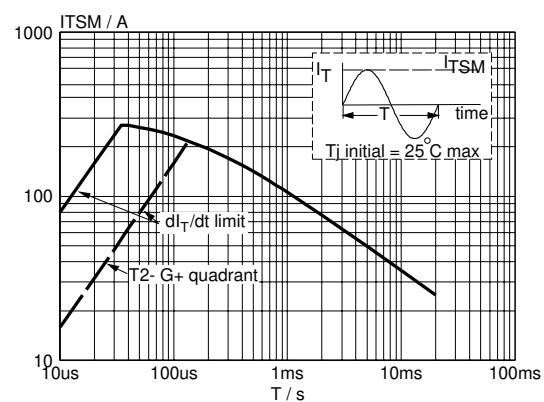


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \leq 20ms$.

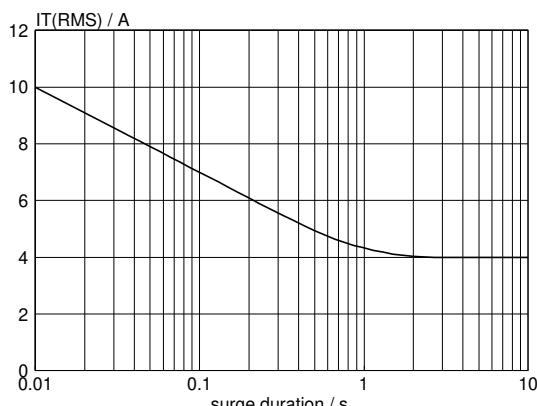


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, $f = 50$ Hz; $T_{mb} \leq 107^\circ\text{C}$.

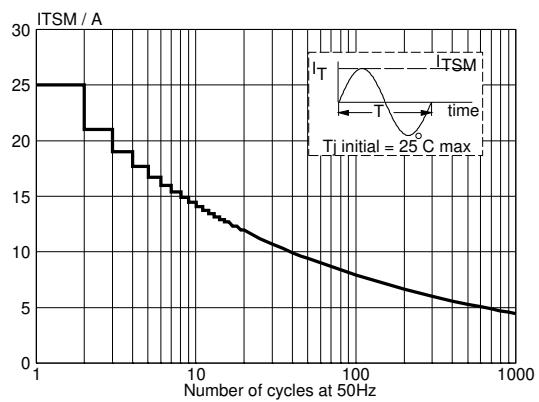


Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, $f = 50$ Hz.

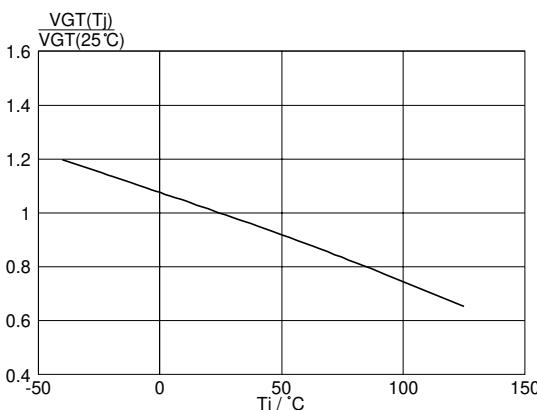


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

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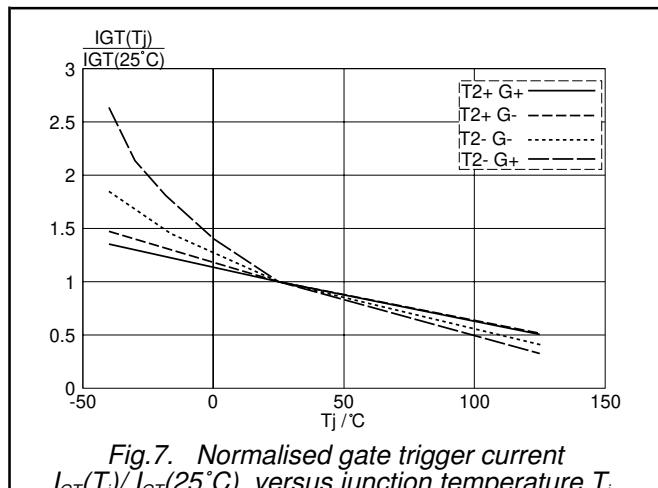


Fig.7. Normalised gate trigger current $I_{GT}(T_j)/I_{GT}(25^\circ\text{C})$, versus junction temperature T_j .

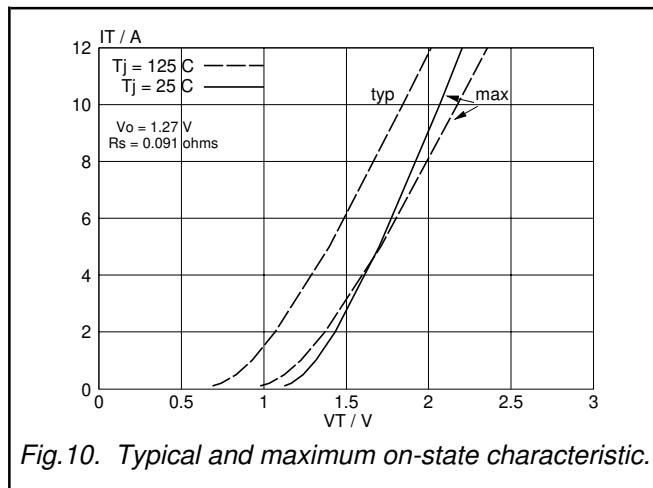


Fig.10. Typical and maximum on-state characteristic.

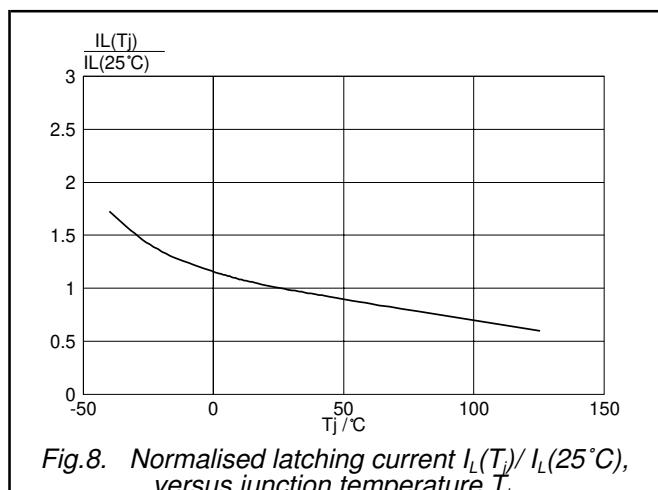


Fig.8. Normalised latching current $I_L(T_j)/I_L(25^\circ\text{C})$, versus junction temperature T_j .

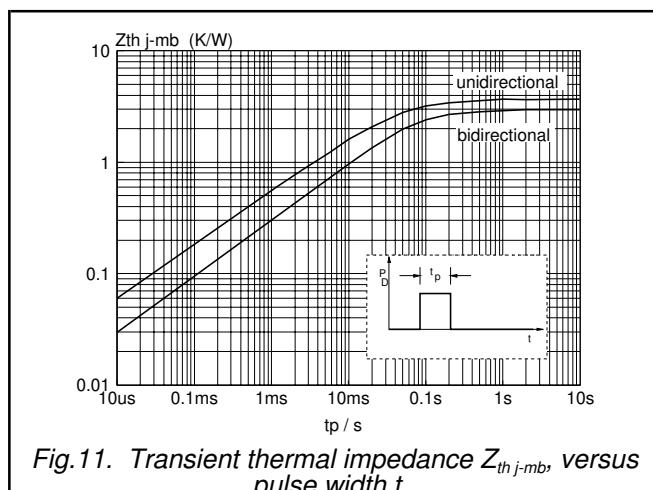


Fig.11. Transient thermal impedance $Z_{th,j-mb}$, versus pulse width t_p .

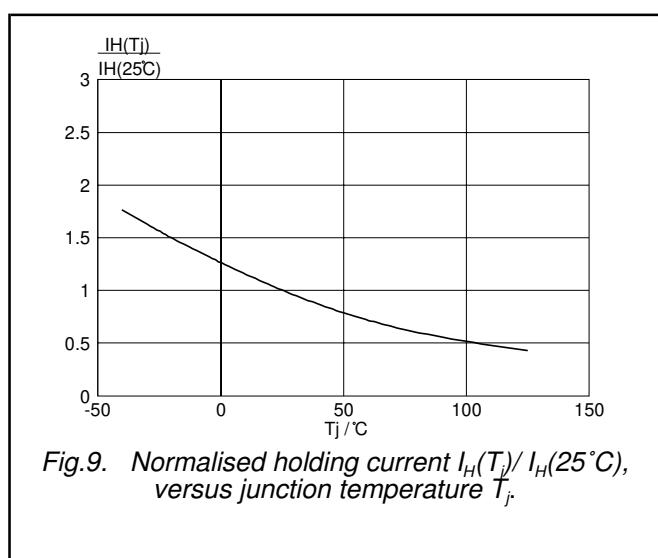


Fig.9. Normalised holding current $I_H(T_j)/I_H(25^\circ\text{C})$, versus junction temperature T_j .

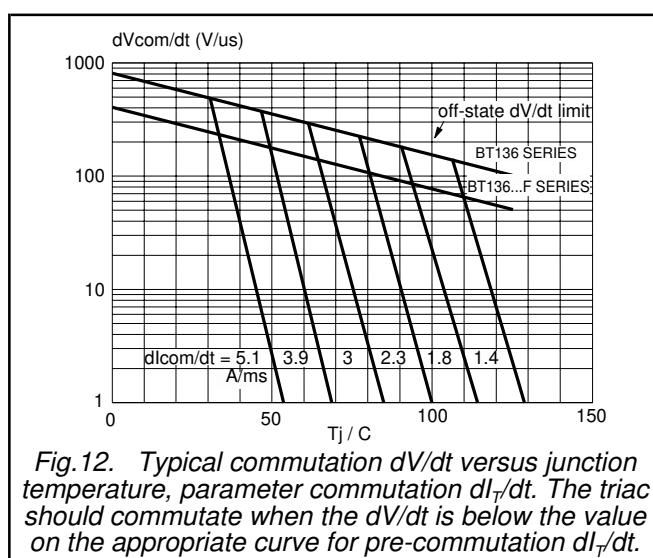


Fig.12. Typical commutation dV/dt versus junction temperature, parameter commutation dl/dt . The triac should commute when the dV/dt is below the value on the appropriate curve for pre-commutation dl/dt .

MECHANICAL DATA

Dimensions in mm

Net Mass: 1.1 g

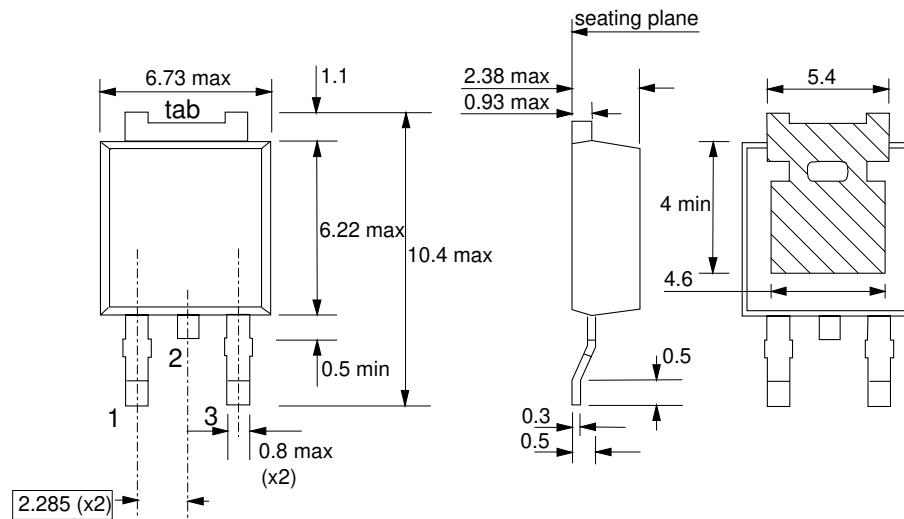


Fig.13. SOT428 : centre pin connected to tab.

MOUNTING INSTRUCTIONS

Dimensions in mm

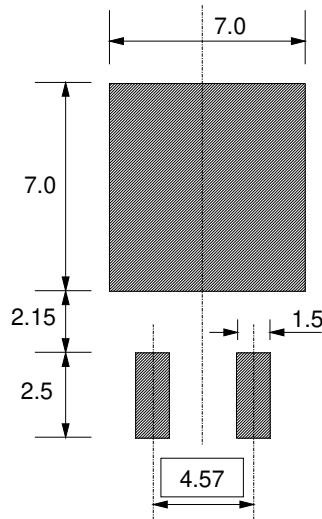


Fig.14. SOT428 : minimum pad sizes for surface mounting.

Notes

1. Plastic meets UL94 V0 at 1/8".